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**JUN 3 0 2005**

**CHIP-PACKAGING WITH BONDING OPTIONS CONNECTED TO A  
PACKAGE SUBSTRATE**

Appl. No. : 10/709,428 Confirmation No. 3427  
Applicant : Cheng-Yen Huang  
Filed : May 5, 2004  
TC/A.U. : 2814  
Examiner : TRINH, HOA B  
Docket No. : FTCP0035USA0  
Customer No. : 27765

Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

**AMENDMENT AND REQUEST FOR CONTINUED EXAMINATION**

5 Sir:

In response to the Office action of May 2, 2004, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

10 **Remarks/Arguments** begin on page 5 of this paper.